

DIGITAL HOT PLATE

SIKAMA HP Series Digital Hot Plate incorporates microcomputer circuitry which controls key parameters. The system is very simple to operate. Temperatures are settable from room temperature to 350°C centigrade in one degree steps. The temperature is also measured by K-type thermocouple, complete with an easy calibration procedure. Aluminum cast plates are used to achieve even temperature and flatness for the most exacting results.

APPLICATION SUGGESTIONS:

- ◆ Surface Mount Component Reflow repair on various substrate materials
- ◆ Hybrid circuit fabrication and repair
- ◆ Temperature cycling of components
- ◆ Curing of components

SPECIFICATIONS:

- ◆ Platen size 8" square (200 x 200 mm)
- ◆ Temperature: Up to 350°C (660°F)
- ◆ Temperature Accuracy: +/- 2°C
- ◆ Warm-up to 250°C: 15 minutes
- ◆ Voltage: 115 or 230 Volts
- ◆ Power: 1200 Watts, 50-60 hz
- ◆ Shipping Weight: 20 lbs (10 Kg)
- ◆ Shipping Dimensions: 12 in W x 17 in D x 8 in H



SIKAMA



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SIMPLE • EFFICIENT • ECONOMICAL

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